

RoHS

COMPLIANT HALOGEN

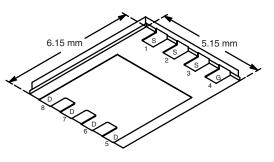
FREE

Vishay Siliconix

N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)	
40	0.0028 at V _{GS} = 10 V	50	38 nC	
	0.0032 at V_{GS} = 4.5 V	50	30110	

PowerPAK[®] SO-8



Bottom View

Ordering Information: SiR414DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Symbol Limit Unit Parameter Drain-Source Voltage V_{DS} 40 V V_{GS} Gate-Source Voltage ± 20 T_C = 25 °C 50^a T_C = 70 °C 50^a Continuous Drain Current (T_{.1} = 150 °C) I_D T_A = 25 °C 33^{b, c} T_A = 70 °C 26^{b, c} А Pulsed Drain Current 70 I_{DM} T_C = 25 °C 50^a Continuous Source-Drain Diode Current I_S T_A = 25 °C 4.9^{b, c} Single Pulse Avalanche Current I_{AS} 40 L = 0.1 mH E_{AS} 80 Single Pulse Avalanche Energy mJ T_C = 25 °C 83 T_C = 70 °C 53 Maximum Power Dissipation P_D W T_A = 25 °C 5.4^{b, c}

T _A = 70 °C		3.4	b, c		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{d, e}		260		Ŭ	
THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	

Parameter			Maximum	Unit	
t ≤ 10 s	R _{thJA}	18	23	°C/W	
Steady State	R _{thJC}	1.0	1.5	0/10	
ľ					

Notes: a. Package Limited.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See Solder Profile <u>(www.vishay.com/ppg264727)</u>. The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 65 °C/W.

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Halogen-free According to IEC 61249-2-21

- TrenchFET[®] Power MOSFET
- 100 % R_g Tested

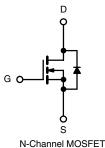
Definition

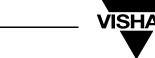
FEATURES

100 % UIS Tested

APPLICATIONS

- Synchronous Rectification
- Secondary Side DC/DC





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SPECIFICATIONS T _J = 25 °C			NA!	T	Merr	11
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		43		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 6		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		2.5	V
Gate-Source Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	looo	$V_{DS} = 40 V, V_{GS} = 0 V$			1	μA
	IDSS	V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 55 °C			10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А
Drain-Source On-State Resistance ^a	Б	V _{GS} = 10 V, I _D = 20 A		0.0023	0.0028	- Ω
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0026	0.0032	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		102		S
Dynamic ^b				1		1
Input Capacitance	C _{iss}			4750		pF
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		610		
Reverse Transfer Capacitance	C _{rss}			275		
		V _{DS} = 20 V, V _{GS} = 10 V, I _D = 20 A		78	117	
Total Gate Charge	Q_g			38	57	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		13	0.	
Gate-Drain Charge	Q _{gd}			11		
Gate Resistance	R _g	f = 1 MHz	0.2	0.7	1.4	Ω
Turn-On Delay Time	t _{d(on)}		0.2	14	25	n
Rise Time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega$		9	18	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		41	65	
Fall Time	t _f	B GEN S G		9	18	
Turn-On Delay Time				33	42	
Rise Time	t _{d(on)} t _r			22	35	
		$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$ $I_{D} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$		42	65	
Turn-Off Delay Time	t _{d(off)} t _f	$G_{\rm EN} = 10^{-1}$, $G_{\rm EN} = 10^{-1}$, $G_{\rm EN} = 12^{-1}$				
Fall Time Drain-Source Body Diode Characteris				13	25	
Continuous Source-Drain Diode	0103			1		
Current	۱ _S	T _C = 25 °C			50	А
Pulse Diode Forward Current ^a	I _{SM}				60	1
Body Diode Voltage	V _{SD}	I _S = 5 A		0.75	1.1	V
Body Diode Reverse Recovery Time	t _{rr}			40	60	ns
Body Diode Reverse Recovery Charge	Q _{rr}			48	72	nC
everse Recovery Fall Time t _a		$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		24		
Reverse Recovery Rise Time	t _b			16		ns

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

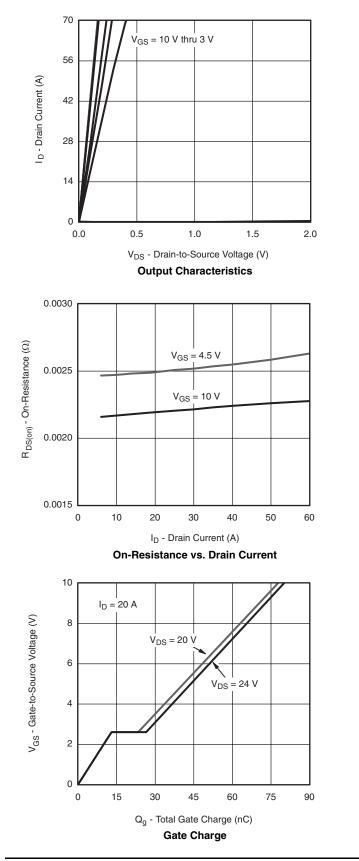
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

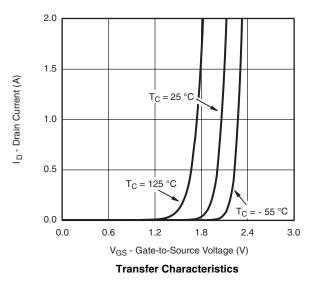


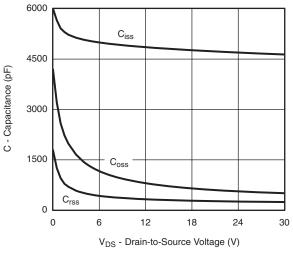


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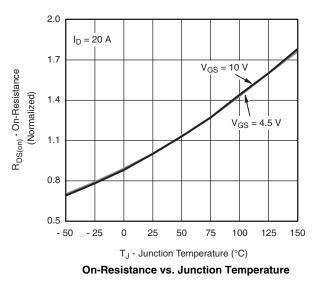










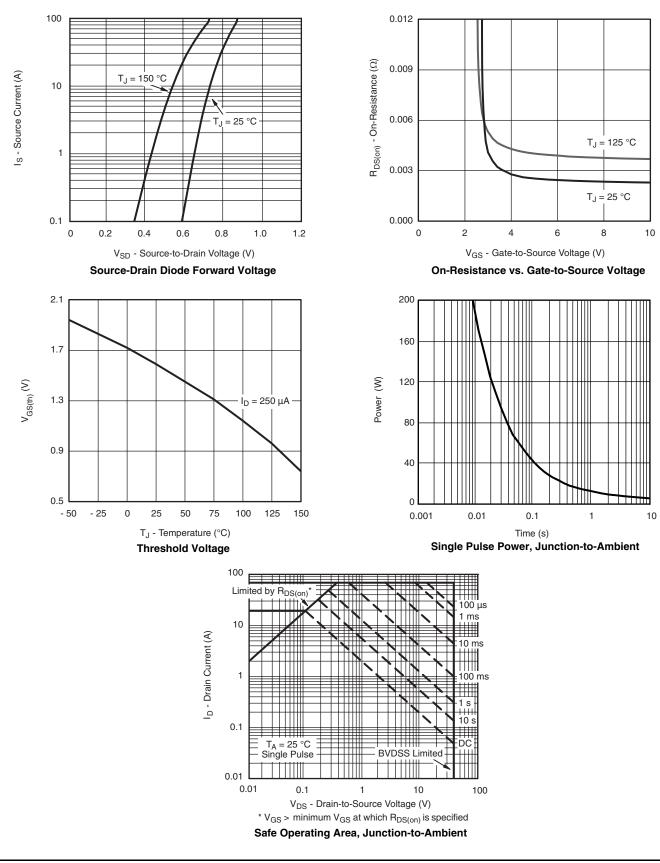


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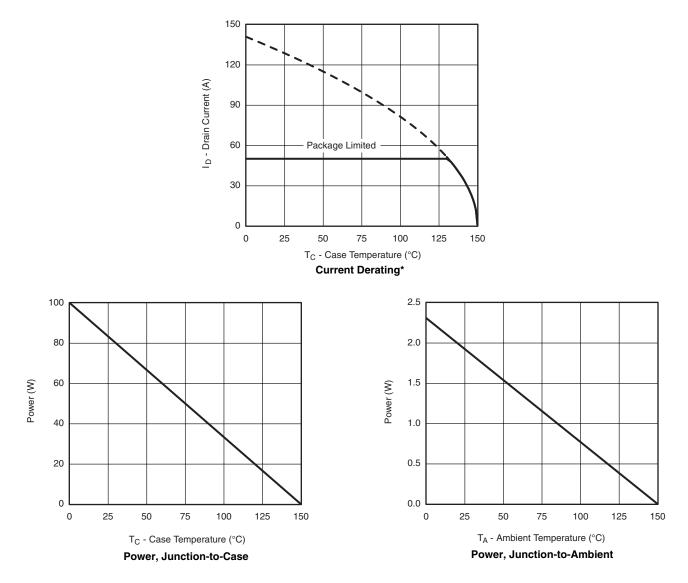
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





SiR414DP Vishay Siliconix

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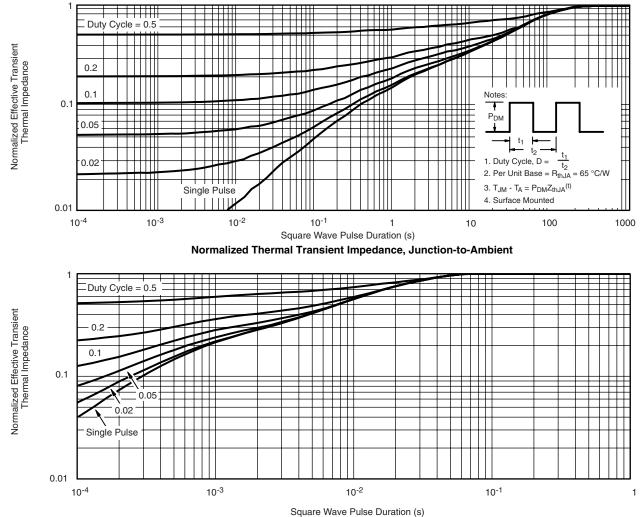


* The power dissipation P_D is based on $T_{J(max)} = 150 \text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?64727.



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